







# DISCRIPTION

#### **FEATURES**

Multilayer ceramic structure
Closed magnetic circuit
Avoids crosstalk
Excellent solderability
High reliability

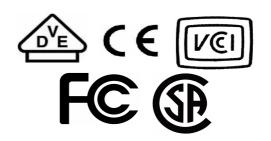
#### **OPTIONS**

Tape & Reel is Standard (Qty: 4.000 Pcs)
Bulk Packing Available for smaller quantites
Tolerance: K=10%, M=20% is Standard,
tighter Tolerance available (MOQ on request)

# **APPLICATIONS**

VCRs
Mobile Radios
Cordless Telephones
Modems
Global Position Systems
Wirless Communications Equipment
Network Systems
Computer Products

#### **APPROVAL**



# PHYSICAL CHARACTERISTICS

• Testing : ( Equivalents acceptable ) Inductance & Q-HP4195A + HP41951

DCR: VOAC-7412; SRF: HP8753C

• Solderability: 90% of the terminal Electrode shall be covered

Preheat :  $260^{\circ}$ C ±  $5^{\circ}$ C for 160 second

Solder: H63AA Eutectic Solder; Flux: Rusin, DIP for 5 seconds ± 1 second

• Thermal Shock: Inductance shall be within ± 5% of initial value nd Q shall be of initial value when temperature is -40°C and 85°C for 30 min. for each 100 cycles

Operating Temperature : -25°C ~ 85°C
Storage Temperature : -40°C ~ 85°C

#### **ELECTRICAL SPECIFICATIONS**

Properties	Test conditions		Value	Unit	Tol.
Inductance		L	47	μH	see Site 2
Q factor		Q	50		min.
DC-resistance		DCR typ.		Ω	typ.
DC-resistance		DCR max.	1,25	Ω	max.
Self-Res. Freq.		SRF	41	Mhz	min.
Test-Freq.			1	Mhz	
Rated Current		IDC	200	mA	max.
Saturation Current		İsat		mA	typ.

1. This electronic component is meant to be used in general electronic equipment. Before the incorporation SMT Multi-Layer of this component into any equipment with higher and more reliable requirements such as aviation, Ceramic Chip Inductors aerospace, submarine, nuclear control, transportation, transportation signal, disaster prevention, medical, public information network, etc. or if there is a possibility of injuries or damages to the human body, Edcon Part No.: S11008-470 -Components must be informed before the stage of design-in. Evaluation checks for safety have to be performed on each electronic components used in electrical circuits that require high safety and reliability Customer: functions. DRW: Chang CHKD Young MATL: Chu Chi DATE 08.06.2009 APPD: **FINISH** Pong Vienna Sheet 1 from 2



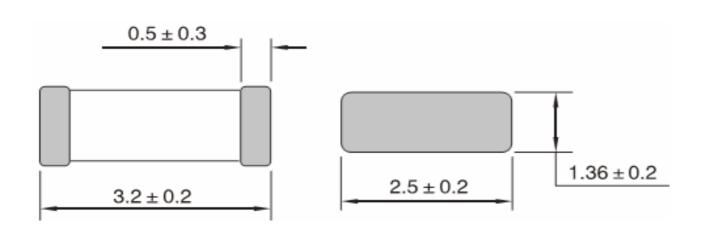






# **TECHNICAL INFORMATIONS**

#### Dimensions ( mm )



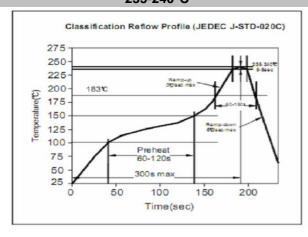
# **Ordering Information**

Serie and Range				
S11008-470				

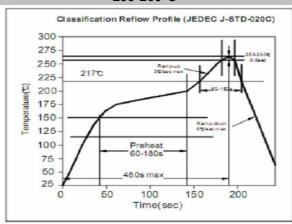
Tolerance	ROHS	Packing	
•			
K	R	TR	
• •		• • • • • • • • • • • • • • • • • • • •	

<b>K</b> = 10%	R = ROHS	<b>BU</b> = Bulk Ware
<b>M</b> = 20%	N = non ROHS	TR = Tape Reel
<b>N</b> = 30%		_

# Soldering Profile for Lead Free Soldering 235-240°C



# Soldering Profile for Lead Free Soldering 255-260°C



1. This electronic component is meant to be used in general electronic equipment. Before the incorporation SMT Multi-Layer of this component into any equipment with higher and more reliable requirements such as aviation, Ceramic Chip Inductors aerospace, submarine, nuclear control, transportation, transportation signal, disaster prevention, medical, public information network, etc. or if there is a possibility of injuries or damages to the human body, Edcon Part No.: S11008-470 -Components must be informed before the stage of design-in. Evaluation checks for safety have to be performed on each electronic components used in electrical circuits that require high safety and reliability Customer: functions. DRW: CHKD MATL: Chu Chi DATE 08.06.2009 Chang Young

Copyright by EDCON-COMPONENTS

**FINISH** 

Vienna

Pong

APPD:

2 from 2

Sheet